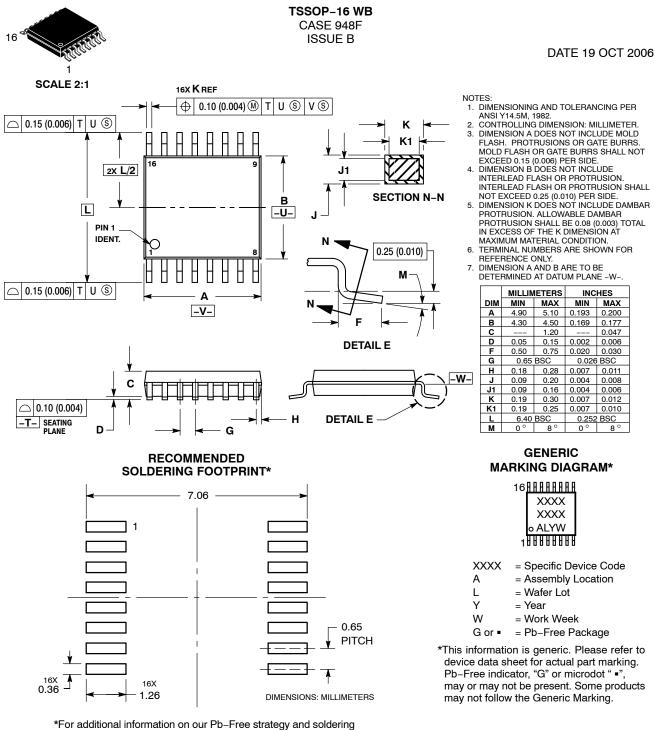
MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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